



# CX51/-16

#### PNP SURFACE MOUNT TRANSISTOR

#### **Features**

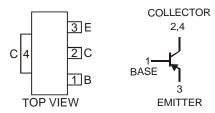
- **Epitaxial Planar Die Construction**
- Complementary NPN Type Available (DCX54)
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

### **Mechanical Data**

- Case: SOT89-3L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking & Type Code Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.072 grams (approximate)



SOT89-3L



Schematic and Pin Configuration

### **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-45	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-45	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5	V
Peak Pulse Current	I <sub>CM</sub>	-1.5	A
Continuous Collector Current	Ic	-1	A

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3) @ T <sub>A</sub> = 25°C	P <sub>D</sub>	1	W
Thermal Resistance, Junction to Ambient Air @ T <sub>A</sub> = 25°C (Note 3)	$R_{ heta JA}$	125	°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics @TA = 25°C unless otherwise specified

Charac	teristic	Symbol	Min	Тур	Max	Unit	Test Conditions
OFF CHARACTERISTICS (Note 4)							
Collector-Base Breakdown Voltage		V <sub>(BR)CBO</sub>	-45	_		V	$I_C = -100 \mu A, I_E = 0A$
Collector-Emitter Breakdown Voltage		$V_{(BR)CEO}$	-45	_	_	V	$I_C = -10 \text{mA}, I_B = 0 \text{A}$
Emitter-Base Breakdown Volta	age	V <sub>(BR)EBO</sub>	-5	_		V	$I_E = -10\mu A, I_C = 0A$
Collector Cut-off Current		1		_	-100	nA	$V_{CB} = -30V, I_{E} = 0$
Collector Cut-on Current		I <sub>CBO</sub>		_	-20	μΑ	$V_{CB} = -30V$ , $I_E = 0$ , $T_A = 150$ °C
Emitter Cut-off Current		I <sub>EBO</sub>	_	_	-100	nA	$V_{EB} = -5V, I_{C} = 0A$
ON CHARACTERISTICS (Note 4)						_	
Collector-Emitter Saturation Voltage		V <sub>CE(SAT)</sub>		_	-0.5	V	$I_C = -500 \text{mA}, I_B = -50 \text{mA}$
Base-Emitter Turn-On Voltage		V <sub>BE(ON)</sub>			-1.0	V	$I_C = -500 \text{mA}, V_{CE} = -2V$
	DCX51, DCX51-16	h <sub>FE</sub> -	63	_		_	$I_C = -5mA$ , $V_{CE} = -2V$
DC Current Gain	•		40	_	_	_	$I_C = -500 \text{mA}, V_{CE} = -2 \text{V}$
DC Current Gain	DCX51		63	_	250	_	$I_C = -150 \text{mA}, V_{CE} = -2 \text{V}$
	DCX51-16		100	_	250	_	$I_C = -150 \text{mA}, V_{CE} = -2 \text{V}$
SMALL SIGNAL CHARACTERISTICS							
Current Gain-Bandwidth Product		f <sub>T</sub>		200	_	MHz	$I_C = -50 \text{mA}, V_{CE} = -5 \text{V},$ f = 100MHz
Output Capacitance		C <sub>obo</sub>			25	pF	$V_{CB} = -10V$ , $f = 1MHz$

Notes:

- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.
- Device mounted on FR-4 PCB; pad layout as shown on page 4 or in Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- Measured under pulsed conditions. Pulse width = 300μs. Duty cycle ≤2%.



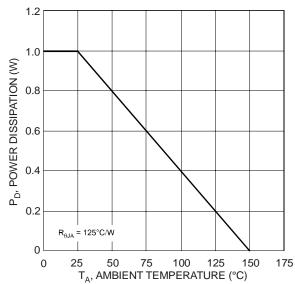


Fig. 1 Power Dissipation vs. Ambient Temperature (Note 3)

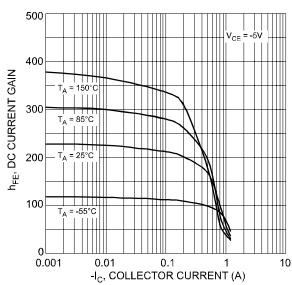


Fig. 3 Typical DC Current Gain vs. Collector Current

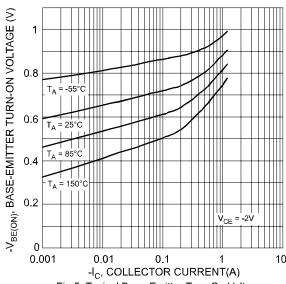
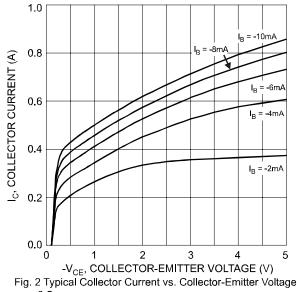


Fig 5. Typical Base-Emitter Turn-On Voltage vs. Collector Current



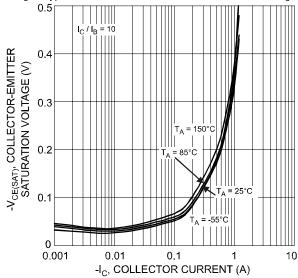


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

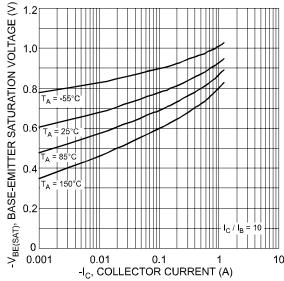
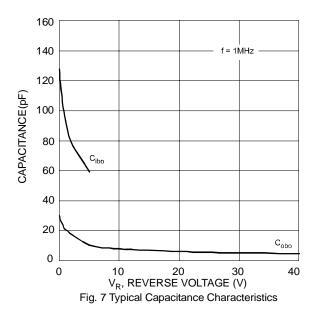


Fig. 6 Typical Base-Emitter Saturation Voltage vs. Collector Current





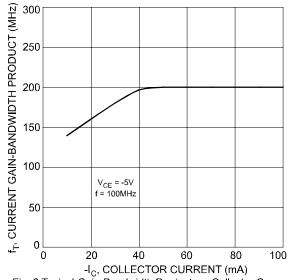


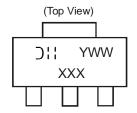
Fig. 8 Typical Gain-Bandwidth Product vs. Collector Current

## **Ordering Information** (Note 5)

Device	Packaging	Shipping
DCX51-13	SOT89-3L	2500/Tape & Reel
DCX51-16-13	SOT89-3L	2500/Tape & Reel

5. For packaging details, go to our website at http://www.diodes.com/ap02007.pdf.

## **Marking Information**

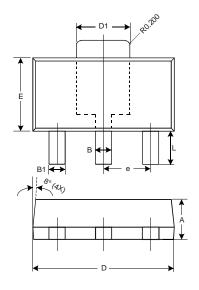


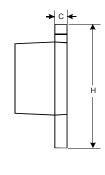
☐ = Manufacturer's code marking XXX = Product type marking code Ex:

P14 = DCX51 P14-16 = DCX51 -16

YWW = Date code marking Y = Last digit of year ex: 7 = 2007 WW = Week code 01 - 52

# **Package Outline Dimensions**

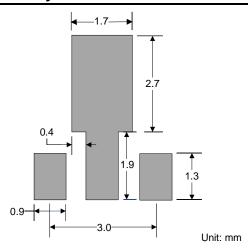




SOT89-3L					
Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
В	0.45	0.55	0.50		
B1	0.37	0.47	0.42		
С	0.35	0.43	0.38		
D	4.40	4.60	4.50		
D1	1.50	1.70	1.60		
E	2.40	2.60	2.50		
е	_	_	1.50		
Н	3.95	4.25	4.10		
L	0.90	1.20	1.05		
All Dimensions in mm					



## **Suggested Pad Layout**



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